

Tentative

TOSHIBA Photocoupler GaAs IRED&Photo-triac

TLP260J

- Triac Drive
- Programmable Controllers
- AC-Output Module
- Solid State Relay

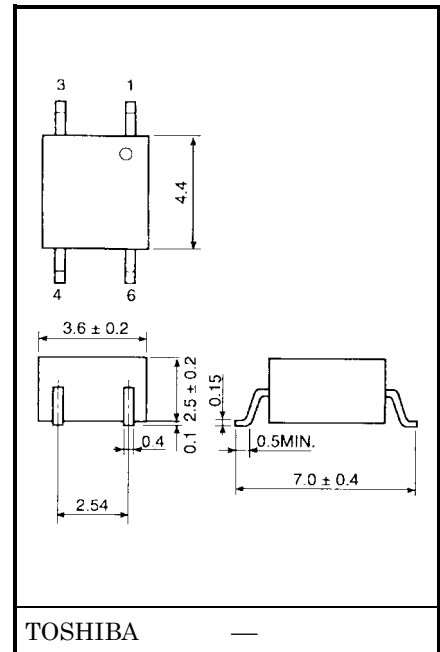
Unit in mm

The TOSHIBA TLP260J is a photocoupler housed in a mini-flat package and consists of a phototriac which is optically coupled to a gallium arsenide infrared-emitting diode.

This type of photocoupler is suitable for use in hybrid ICs as it is thinner and smaller than a 6-pin DIP photocoupler.

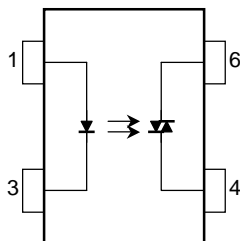
TLP260J: 4-pin mini-flat package (MFSOP6)

- Peak OFF-state voltage: 600 V (min)
- Trigger LED current: 10 mA (max)
- ON-state current: 70 mA (max)
- Isolation voltage: 3000 Vrms (min)



Weight: 0.09 g

Pin Configuration (top view)



- 1: ANODE
- 3: CATHODE
- 4: TERMINAL1
- 6: TERMINAL2

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
LED	Forward current	I_F	50	mA	
	Forward current derating (Ta ≥ 53°C)	$\Delta I_F/^\circ\text{C}$	-0.7	mA/°C	
	Peak forward current (100 μs pulse, 100 pps)	I_{FP}	1	A	
	Reverse voltage	V_R	5	V	
	Junction temperature	T_j	125	°C	
Detector	OFF-state output terminal voltage	V_{DRM}	600	V	
	ON-state RMS current	Ta = 25°C	I_T (RMS)	70	mA
		Ta = 70°C		40	
	ON-state current derating (Ta ≥ 25°C)	$\Delta I_T/^\circ\text{C}$	-0.67	mA/°C	
	Peak ON-state current (100 μs pulse, 120 pps)	I_{TP}	2	A	
	Peak nonrepetitive surge current (PW = 10 ms, DC = 10%)	I_{TSM}	1.2	A	
	Junction temperature	T_j	100	°C	
Storage temperature range	T_{stg}	-55~125	°C		
Operating temperature range	T_{opr}	-40~100	°C		
Lead soldering temperature (10 s)	T_{sol}	260	°C		
Isolation voltage (AC, 1 min, RH ≤ 60%) (Note1)	BV_S	3000	Vrms		

Note1: Pins 1 and 3 shorted together, and pins 4 and 6 shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Typ.	Max	Unit
Supply voltage	V_{AC}	—	—	240	V_{ac}
Forward current	I_F	15	20	25	mA
Peak ON-state current	I_{TP}	—	—	1	A
Operating temperature	T_{opr}	-25	—	85	°C

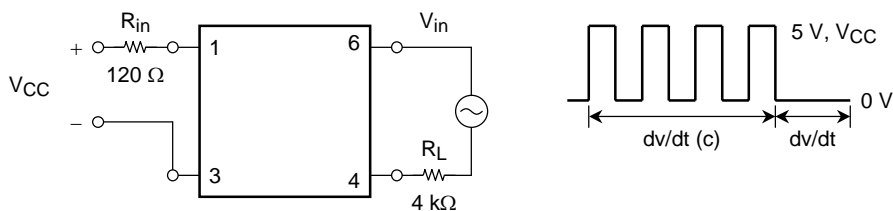
Individual Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	V_F	$I_F = 10 \text{ mA}$	1.0	1.15	1.3	V
	Reverse current	I_R	$V_R = 5 \text{ V}$	—	—	10	μA
	Capacitance	C_T	$V = 0, f = 1 \text{ MHz}$	—	30	—	pF
Detector	Peak OFF-state current	I_{DRM}	$V_{DRM} = 600 \text{ V}$	—	10	1000	nA
	Peak ON-state voltage	V_{TM}	$I_{TM} = 70 \text{ mA}$	—	1.7	2.8	V
	Holding current	I_H	—	—	1.0	—	mA
	Critical rate of rise of OFF-state voltage	dv/dt	$V_{in} = 240 \text{ V}, T_a = 85^\circ\text{C}$ (Note2)	—	500	—	$\text{V}/\mu\text{s}$
	Critical rate of rise of commutating voltage	$dv/dt (c)$	$V_{in} = 60 \text{ Vrms}, I_T = 15 \text{ mA}$ (Note2)	—	0.2	—	$\text{V}/\mu\text{s}$

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Trigger LED current	I_{FT}	$V_T = 6 \text{ V}$	—	—	10	mA
Capacitance input to output	C_S	$V_S = 0, f = 1 \text{ MHz}$	—	0.8	—	pF
Isolation resistance	R_S	$V_S = 500 \text{ V}, RH \leq 60\%$	5×10^{10}	10^{14}	—	Ω
Isolation voltage	BV_S	AC, 1 min.	3000	—	—	Vrms
		AC, 1 s, in oil	—	5000	—	Vrms
		DC, 1 min., in oil	—	5000	—	Vdc
Turn-on time	t_{ON}	$V_D = 6 \rightarrow 4 \text{ V}, R_L = 100 \Omega,$ $I_F = \text{Rated } I_{FT} \times 1.5$	—	30	100	μs

Note2: dv/dt test circuit



RESTRICTIONS ON PRODUCT USE

000707EBC

- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
- Gallium arsenide (GaAs) is a substance used in the products described in this document. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them. When disposing of the products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with domestic garbage.
- The products described in this document are subject to the foreign exchange and foreign trade laws.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.
- The information contained herein is subject to change without notice.